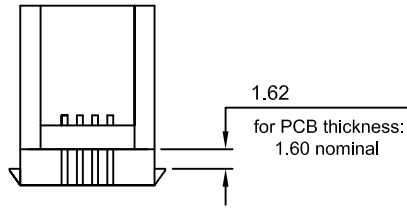
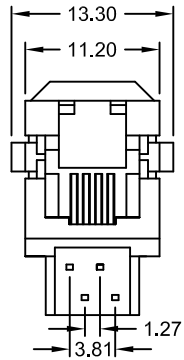


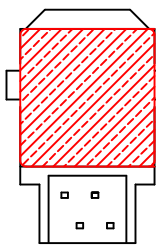
REV.	DESCRIPTION	DATE	DRAWN
A	New	12.04.2013	Ronny
B	correct Layout DIM 13.35 -> 11.35	21.05.2013	Ronny
C	P/N -H130- -> -S1C0- & 3D	17.06.2016	Ronny



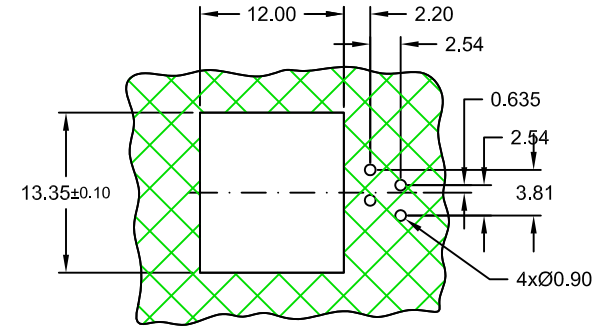
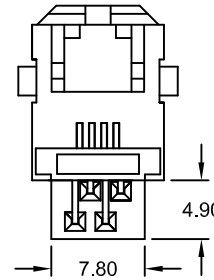
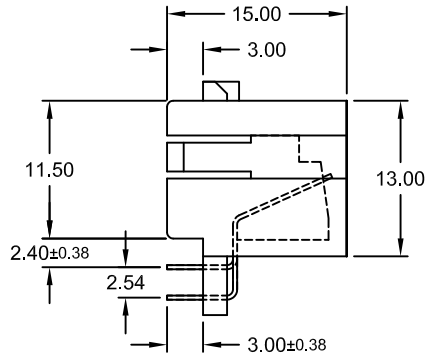
Bottom view without Solder stop



Bottom view with Solder stop



Option
Solder stop
standard without Solder stop
/S with Solder stop



Recommended PCB Layout Top View
(Tolerance ±0.05)



Specifications

Electrical

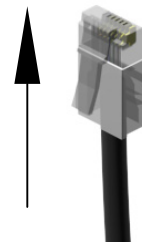
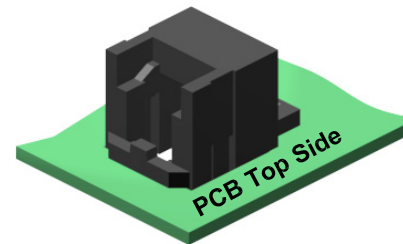
Current rating: 1.5A max. (@25°C)
Insulation resistance: 500MΩ min.
Voltage rating: 150V AC max.
Withstanding voltage: 1000V rms / Minute (60Hz)
Contact resistance: 20mΩ max.

Material

Contact: Phosphor Bronze t=0.35mm
Plating: Sn/Au over Ni
Insulator: PBT (black) UL 94V-0

Operating temperature: -40°C to +85°C

Cavity comply with FCC Rules and Regulations Part 68, Subpart F



Modular Jack delivered with Plastic solder stop installed, to prevent solder entering the Jack.
Remove solder stop after soldering.

PART NUMBER	GOLD PLATING CONTACT AREA
MJB-144-S1C0-96/S	6μ"
MJB-144-S1C0-97/S	15μ"
MJB-144-S1C0-98/S	30μ"
MJB-144-S1C0-9H/S	50μ"

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UNIT	GENERAL TOLERANCE		DRAWN	DATE	DWG. NO.	SHEET 1/1
mm	X.° ±	X. ±	Ronny	12.12.2009	1211100	REV. C
SCALE	.X° ±	.X ±	Hogi	17.03.2016	SERIES NO.	
Free	.XX° ±	.XX ± 0.25	APPROVE	DATE	MJB-144-S1C0-9x/X	
	.XXX° ±	.XXX ±	Hogi	17.03.2016		

RJ9 PCB JACK <4P4C>
Bottom entry Type
non shielded